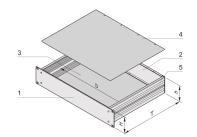


20860-604 MULTIPACPRO 19" CHASSIS, ALUMINUM, PLAIN TOP AND BASE, 2 U, 220 MM





KEY FEATURES

Aluminum construction

Detachable front and rear panel for easy machining

IP 20, in accordance with IEC 60529

Supplied as space-saving flat-pack

Modifications such as cutouts, different finishes or dimensions available

Internal and external dimensions in accordance with: IEC 60297-3-100, -105

EMC shielding: Approx. 20dB(A) at 2 GHz without shielding material. >40dB(A) at 1 GHz with addition of stainless steel gasket between front panel and case body

PRODUCT ATTRIBUTES

Product Type: Subrack/Chassis
Product Family: MultipacPRO
Type: Solid
Rack Height: 2 U
Depth: 220 mm
Usable Width: 4 mm
EMC Shielding: No (Retrofittable)
Mounting: Rack
Complies With: IEC 60297-3-100

This 19" chassis is a form of subrack which accepts horizontal board mounting or the mounting of non-standard components like transformers or other heavy load accessories typically mounted on a chassis plate. This version have plain top and bottom cover.

Please order front handles separately.

North America

All locations +1.763.422.2661 Chat with us: schroff.nvent.com

Europe

Straubenhardt, Germany +49.7082.794.0 Betschdorf, France +33.3.88.90.64.90 Warsaw, Poland +48.22.209.98.35 Assago, Italy +39.02.932.7141 Chat with us: schroff.nvent.com

nVent.com

Asia

Shanghai, China +86.21.2412.6943 Qingdao, China +86.532.8771.6101 Singapore +65.6768.5800 Shin-Yokohama, Japan +81.45.476.0271 Chat with us: schroff.nvent.com

CADDY ERICO HOFFMAN RAYCHEM SCHROFF TRACER

Middle East & India

Dubai, United Arab Emirates +971.4.378.1700 Bangalore, India +91.80.6715.2001 Istanbul, Turkey +90.216.250.7374 Chat with us: schroff.nvent.com



© 2023 nVent. All nVent marks and logos are owned or licensed by nVent Services GmbH or its affiliates. All other trademarks are the property of their respective owners.

Our powerful portfolio of brands:

nVent reserves the right to change specifications without notice.